

MS-15

The way to Industry 4.0
MIRTEC

PCB Size Range (mm)		S	M
Triple Stage Conveyor	Single Lane	-	50 x 50 - 510 x 460
	Dual Lane	50 x 50 - 330 x 280	-

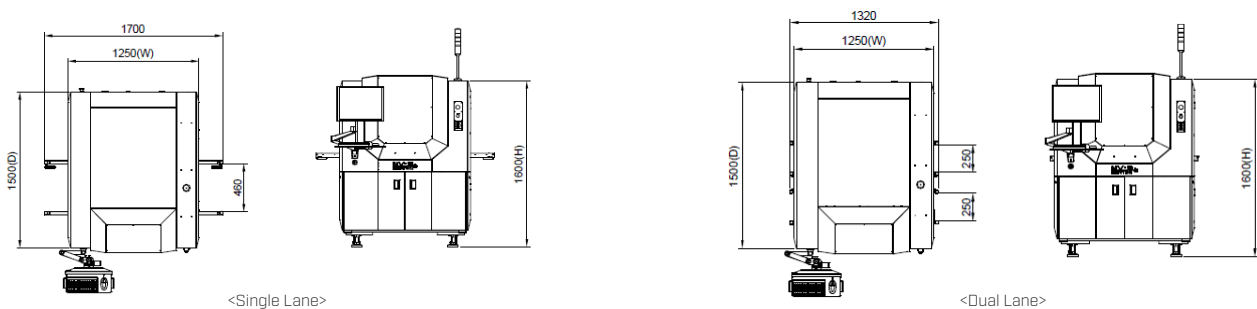
Inspection Technology			
3D Inspection Technology		Shadow Free - Moiré 3D Phase Shift Image Processing	
Lens Configuration		Precision Telecentric Compound Lens	
Solder Height	Maximum	600µm (Option : 650µm)	
	Minimum	40µm	

System Specification			
PCB Handling	Clearance	Top	25mm
		Bottom	25mm
	Thickness		0.5 - 5mm
	Weight		4kg
Software	Standard	Built-in SPC, Built-in Repair, Gerber Pad	
	Option	ePM-SPI, RMS, RRS, IRS, OLTT, Remote SPC, SPC Server System	
Power Requirements		Single Phase(s) 200-240V 50-60Hz, 1.5kw	Single Phase(s) 200-240V 50-60Hz, 1.1kw
Air Requirements		5 Kgf / cm ² (0.5 MPa)	

Dimension(WxDxH) (mm)			
Machine Dimension (Total Width : Machine & Conveyor)	Triple Stage Conveyor	Single Lane	-
		Dual Lane	1,250 x 1,500 x 1,600 (1,280)
			1,250 x 1,500 x 1,600 (1,700)

Weight			
Weight	Triple Stage Conveyor	Single Lane	-
		Dual Lane	Approx. 1,400kg
			Approx. 1,200kg

※ We will not be responsible for any problems caused by using unverified BARCODE READER. Contact our HQ for the list of allowed BARCODE READER models to use.



• Data subject to change without notice.



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